

DAC121S101EVM Booster Pack User's Guide

User's Guide



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DAC121S101 BoosterPack Components

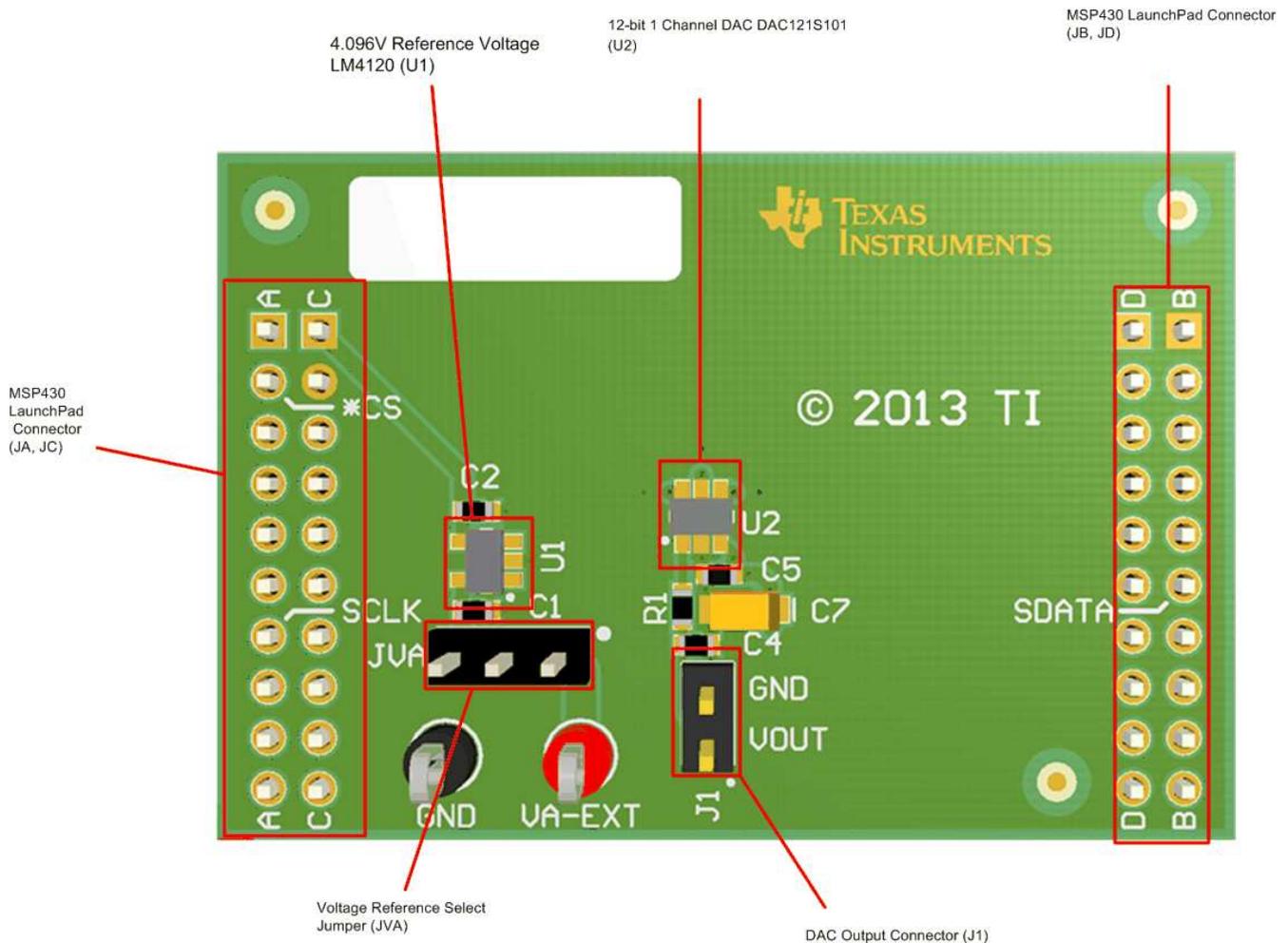


Figure 1-1. DAC121S101EVM Evaluation Board

Table 1-1. Device and Package Configurations

| DEVICE | IC | PACKAGE |
|--------|----------------|---------|
| U1 | LM4120IM5-4.1 | SOT-23 |
| U2 | DAC128S085CIMK | SOT-6 |

Software Installation

2.1 Graphical User Interface (GUI)

To use the DAC121S101EVM install the DAC12xSxxx Software:

1. The DAC12xSxxx software is located <http://www.ti.com/product/dac121s101>, scroll down to the “software” section, and download the latest evaluation software.
2. Unzip the downloaded file into a known directory, and run the “setup.exe” file located in [Unzip location] \ DAC12xSxxx \EVM_GUI\ DAC12xSxxx _Installer_v1.zip\ DAC12xSxxx _Installer\Installer\Volume. Follow the pop-screen instructions by clicking the “Next” button to install the software.

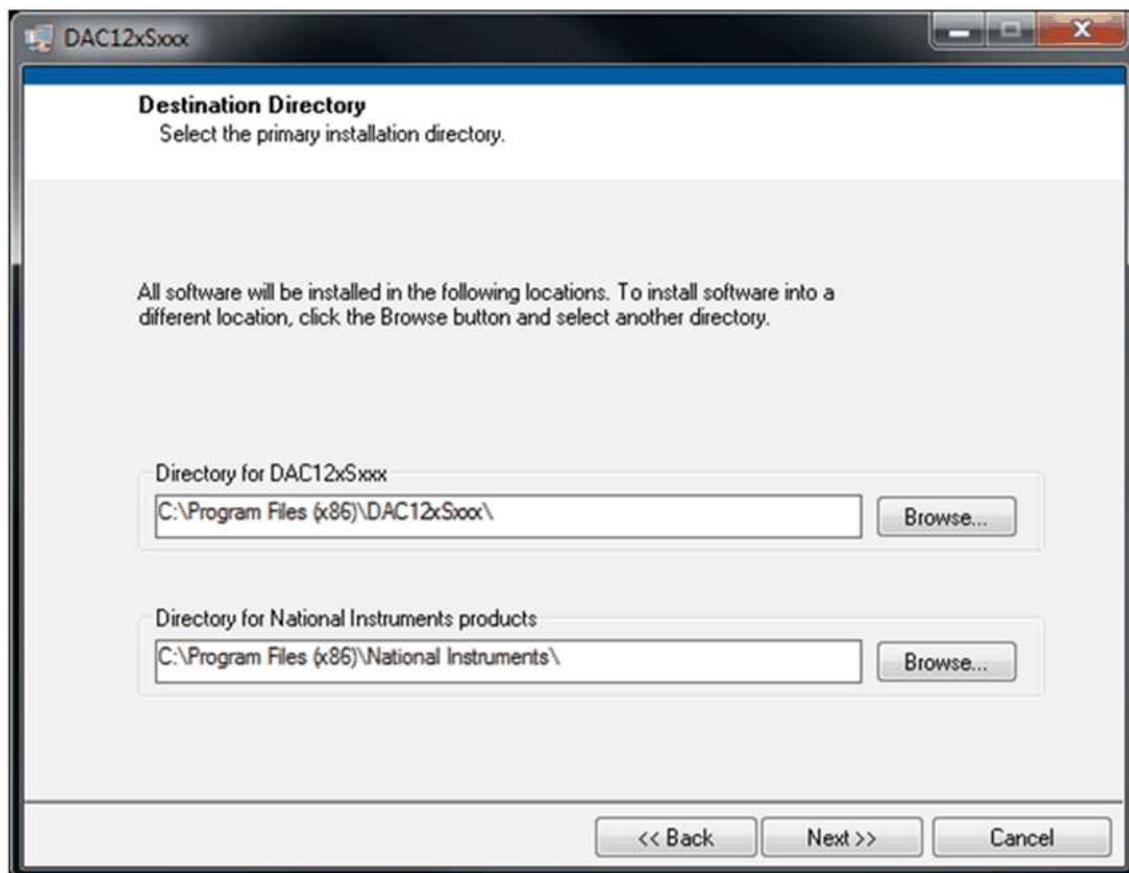


Figure 2-1. DAC12xSxxx Installation Directory

3. When the installation is finished, please click “Finish” button.

2.2 LaunchPad Firmware Upgrade

The MSP430F5529 LaunchPad board can be purchased at <http://www.ti.com/tool/msp-exp430f5529lp>.

MSP430 Firmware Upgrade Application Installation

1. Navigate to <http://www.ti.com/tool/msp430usbdevpack> and click on Get Software.
2. Scroll-down to the end of the page to find the USB Collateral Installers section.
3. Click on MSP430_USB_Firmware_Upgrade_Example-x-x-x-Setup.exe to download the tool; the page will redirect to a submission form.
4. Complete the information requested and submit the form; if approved, a download button will appear.
5. Run the installation file and follow the on-screen instructions until completion. When asked about the setup type, select Application Only. Click Finish when done.

Firmware upgrade

1. Open the MSP430 USB Firmware Upgrade application. By default, the application can be launched from Start >> Programs >> Texas Instruments >> MSP430 USB Firmware Upgrade Example.
2. Click Next to proceed on the first prompt; read and accept the license agreement and click Next to continue.

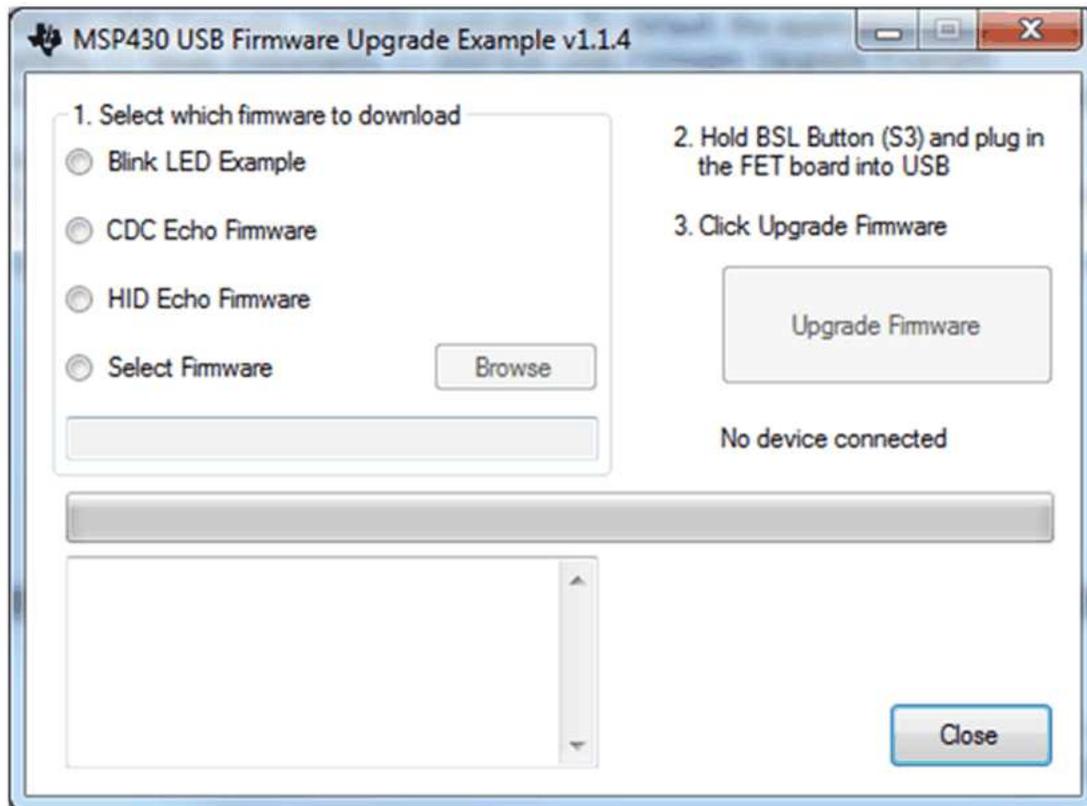


Figure 2-2. USB Firmware Upgrade Window

3. Enable the Select Firmware button and browse to the downloaded firmware "dac12xsxxx_fw-v0.87.txt".
4. Press the BSL button on the MSP430 LaunchPad and connect to the PC with a USB cable; if detected, the text on the Firmware Upgrade tool will change from "No device connected" to "Found 1 device".
5. Click on the Upgrade Firmware button to program the LaunchPad. Close the application when done.

2.3 Update USB Driver

1. Before launching the DAC12xSxxx software, connect the DAC121S101EVM board to a USB port of your PC. Go to Device Manager and find "MSP43-USB Example". Right click and select Update Driver Software.

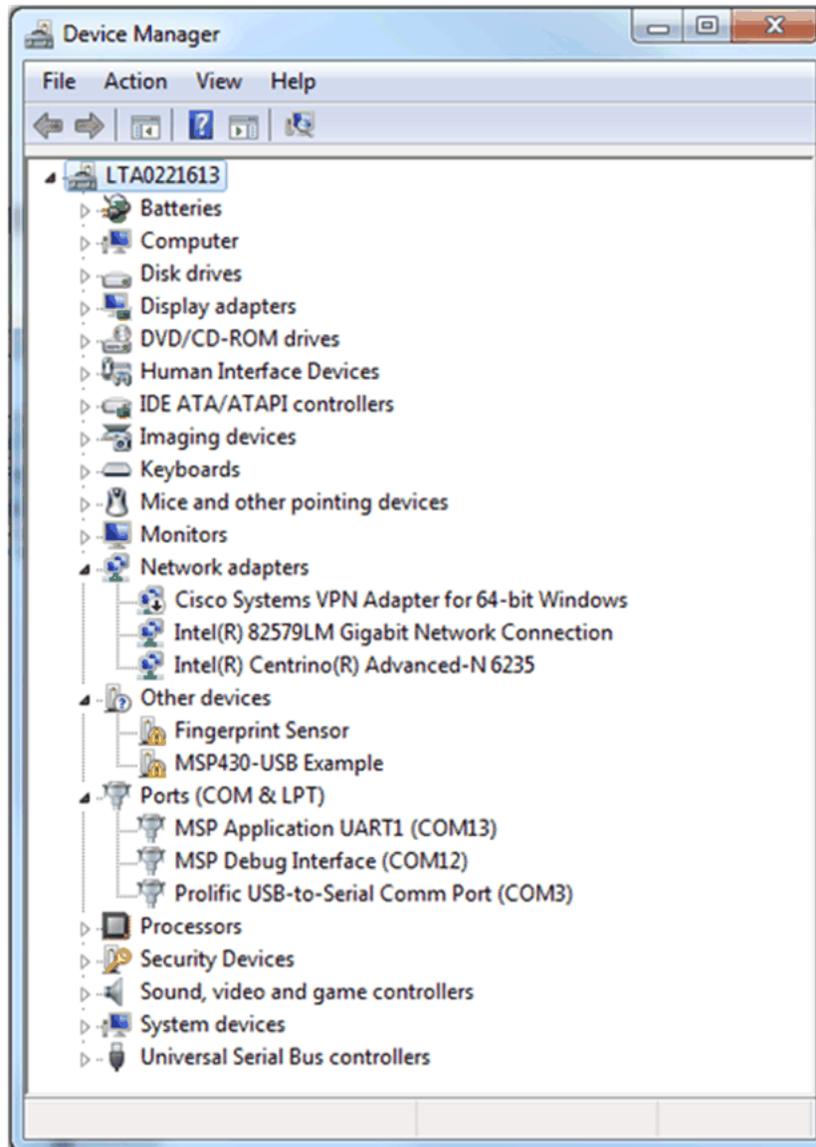


Figure 2-3. Driver Not Installed

2. On the next screen, select the "Browse my computer for driver software" option and go to the directory of your install files and select the "TI_ADC_DAC_EVMs_Driver.inf" file.
3. If prompted with a warning window select "Install this Driver Anyway". Close the installation window when it is done. The device manager should now display a "TI_ADC_DAC_EVMs" item followed by a COM port number.

DAC121S101 BoosterPack Setup and Operation

3.1 Connections

1. Attach the DAC121S101EVM BoosterPack onto the MSP430F5529 LaunchPad using connectors JA, JB, JC, JD. The proper orientation of the LaunchPad and DAC121S101EVM is when the text “LaunchPad” and “2013 TI” are in the same direction.



Figure 3-1. DAC121S101EVM Attached to MSP430

2. Connect the USB cable from the LaunchPad to the PC.

3.2 Launching the Software

1. The DAC12xSxxx GUI software can be run by clicking on Start >> All Program >> DAC12xSxxx. After running the GUI select DAC121S101.

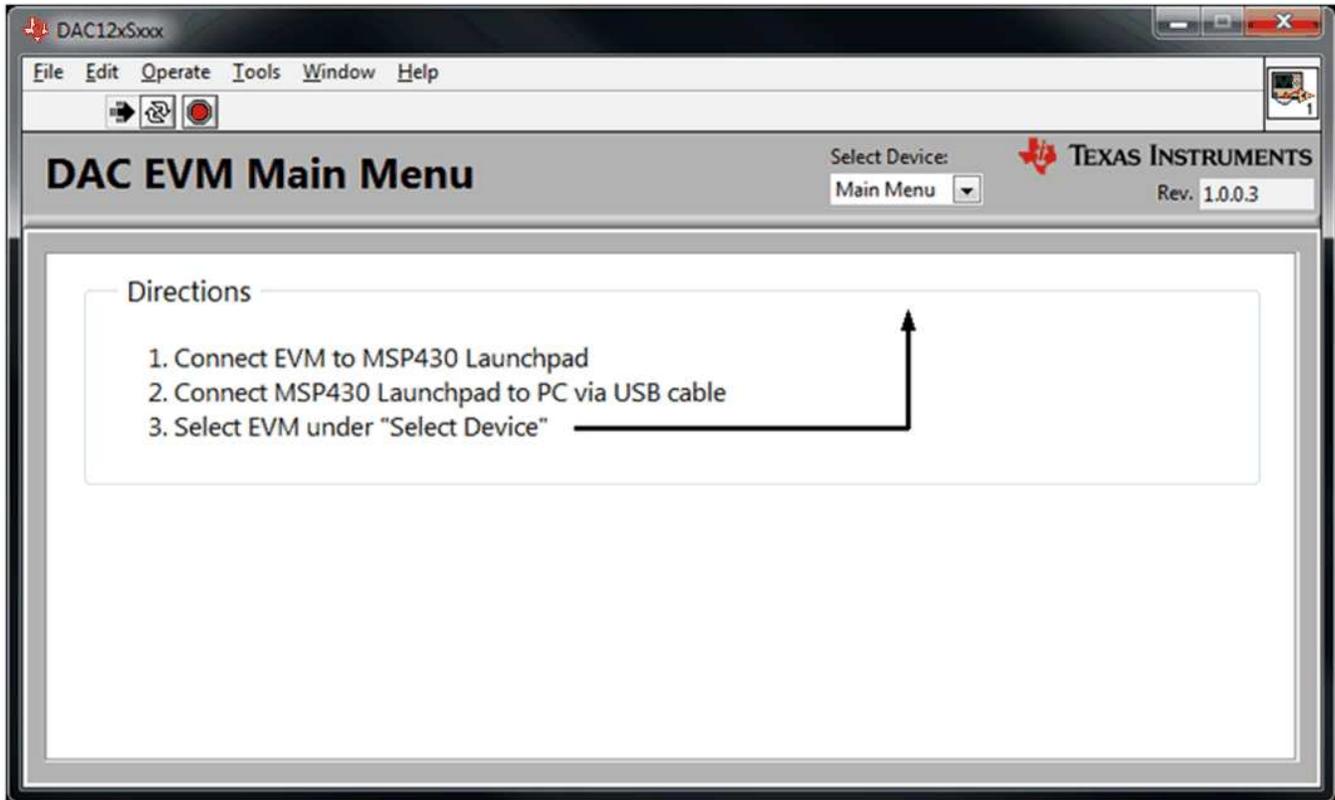


Figure 3-2. Part Select

2. GUI Descriptions
 - DB[15:12]: These 4 bits control different operational and power down modes. Bits 14 and 15 are don't care bits. See the DAC121S101 datasheet for more details.
 - DB[11:0]: These 12 bits are for setting the DAC output codes.
 - DB[11:0] Output Type: This field changes DB[11:0] to either binary, decimal, or hexadecimal type.
3. Quick start:
 - (a) Input "0000" to DB[15:12] to go into normal operation mode
 - (b) Input "800" to DB[11:0] to output 2.048V ($V_{ref}/2$)
 - (c) Click "Write" to send the command to the DAC121S101 part

Board Layout

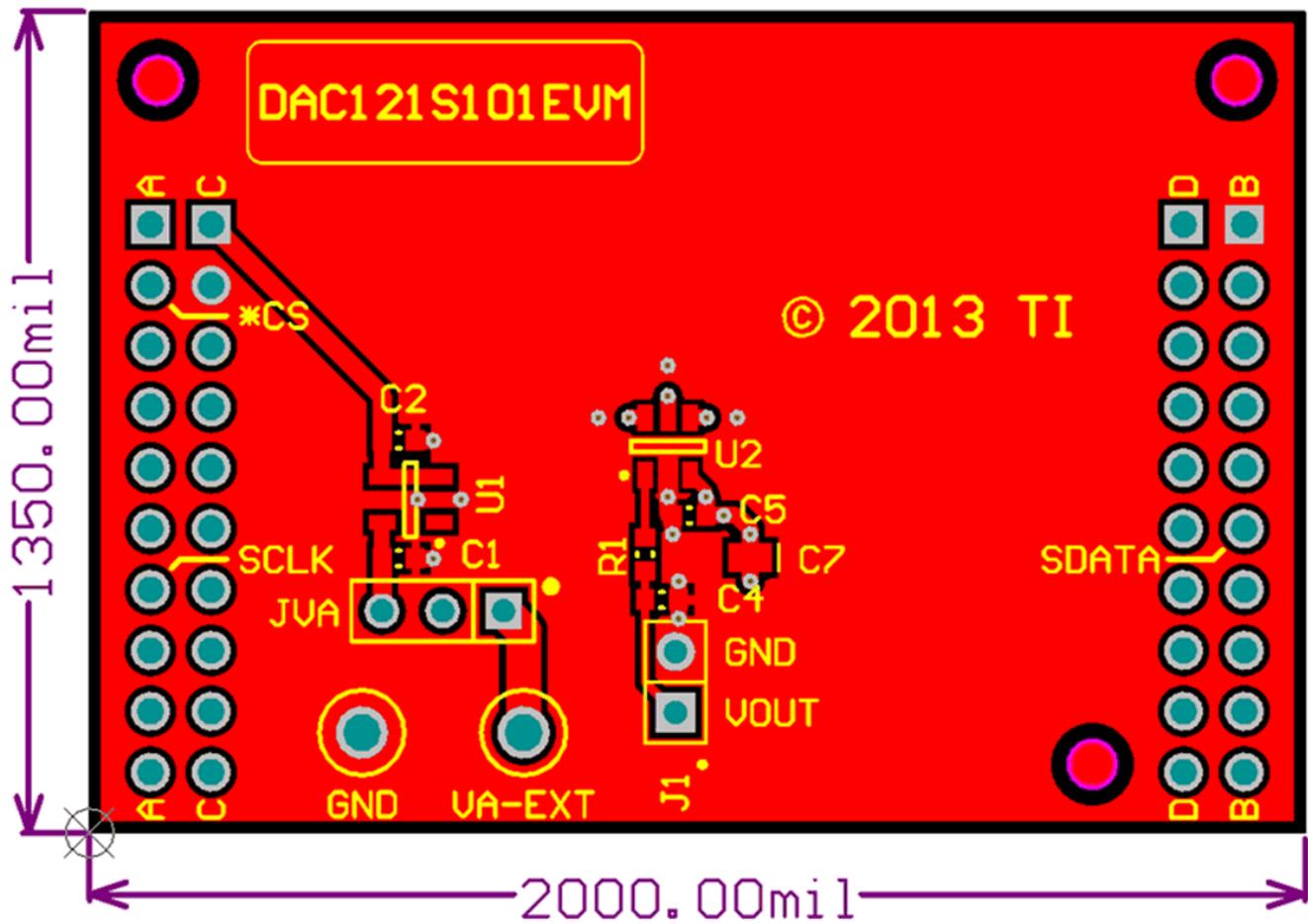


Figure 4-1. Top Assembly Layer

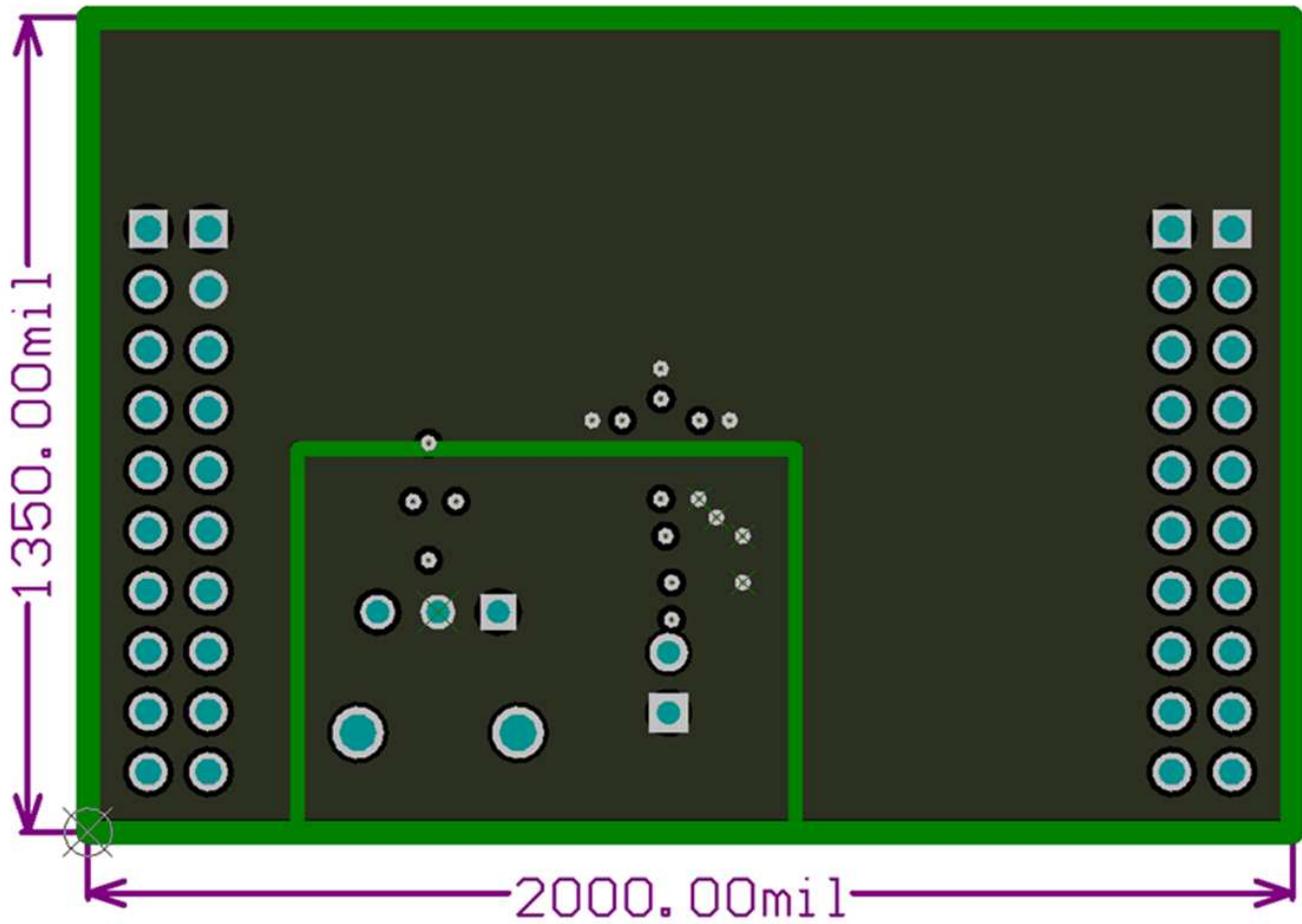


Figure 4-3. Power Layer Routing

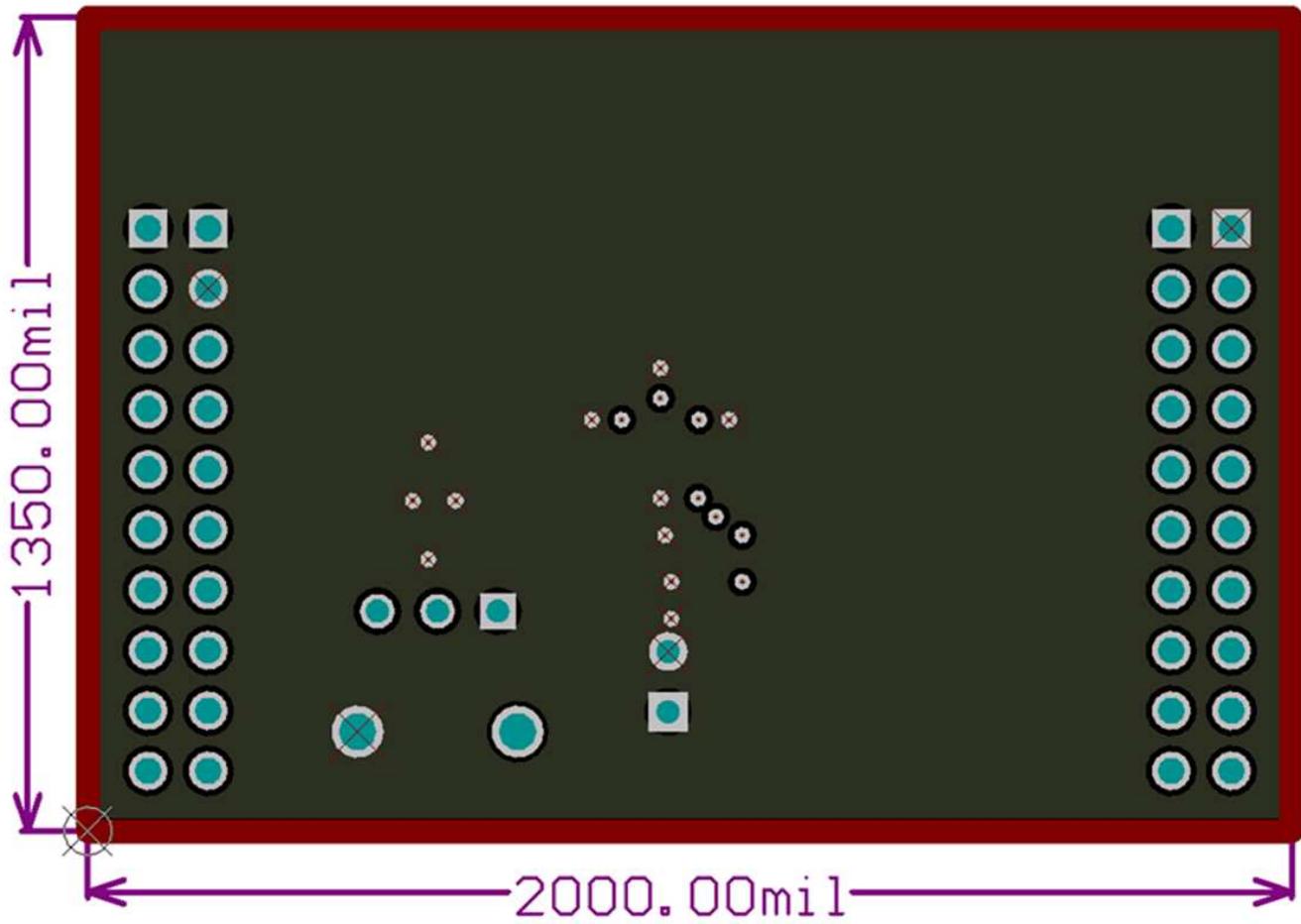


Figure 4-4. Ground Layer Routing

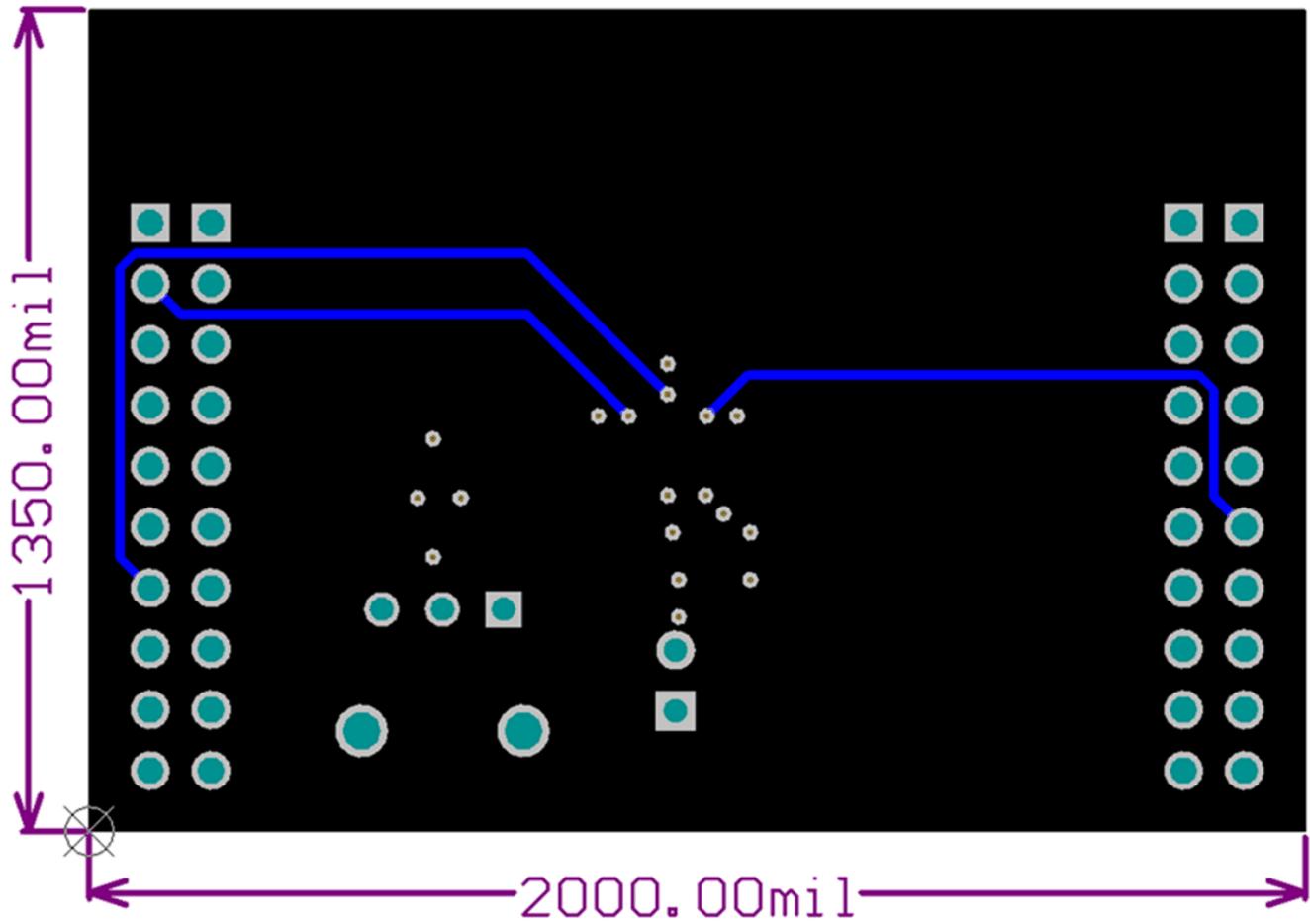


Figure 4-5. Bottom Layer Routing

Schematic

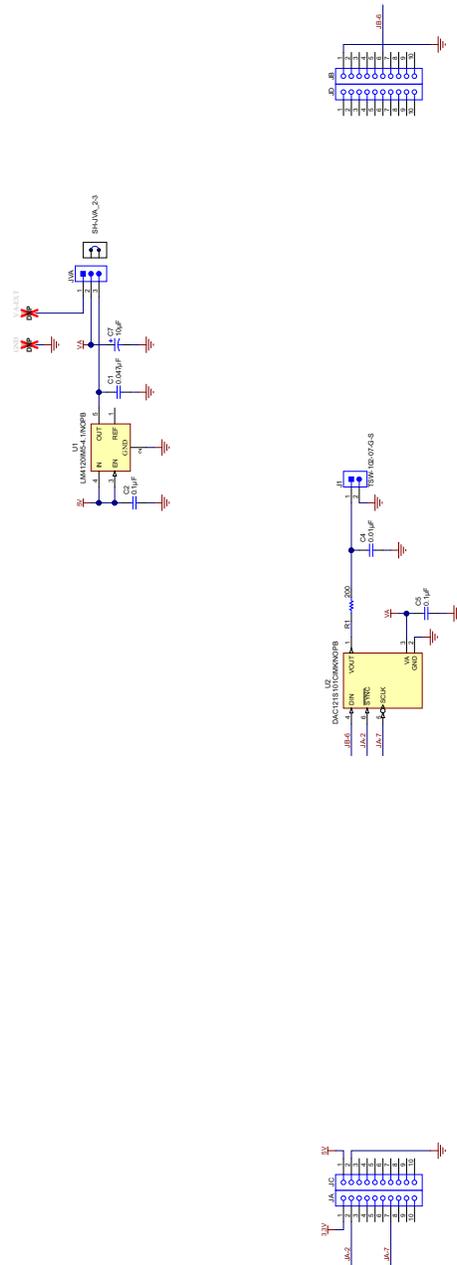


Figure 5-1. DAC121S101EVM Schematic

Bill of Materials

Table 6-1. DAC121S101 Bill of Materials

| Designator | Quantity | Value | Description | Part Number | Manufacturer |
|------------------|----------|-------------------------|--|-------------------------|-----------------------------|
| !PCB | 1 | | Printed Circuit Board | SV601042 | Any |
| C1 | 1 | 0.047 μ <i>f</i> | CAP, CERM, 0.047 μ F, 6.3V, +/-10%, X7R, 0603 | GRM188R70J473KA01 D | MuRata |
| C2, C5 | 2 | 0.1 μ F | CAP, CERM, 0.1 μ F, 10V, +/-10%, X7R, 0603 | C0603C104K8RACTU | Kemet |
| C4 | 1 | 0.01 μ F | CAP, CERM, 0.01 μ F, 25V, +/-10%, X7R, 0603 | GRM188R71E103KA01 D | MuRata |
| C7 | 1 | 10 μ F | CAP, TA, 10 μ F, 10V, +/-10%, 0.9 ohm, SMD | TPSA106K010R0900 | AVX |
| J1 | 1 | | Header, TH, 100mil, 2x1, Gold plated, 230 mil above insulator | TSW-102-07-G-S | Samtec |
| JA, JB, JC, JD | 4 | | Connector, Receptacle, 100mil, 10x1, Gold plated, TH | SSW-110-23-F-S | Samtec |
| JVA | 1 | | Header, 100mil, 3x1, Tin plated, TH | PEC03SAAN | Sullins Connector Solutions |
| LBL1 | 1 | | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll | THT-14-423-10 | Brady |
| R1 | 1 | 200 | RES, 200 ohm, 1%, 0.1W, 0603 | CRCW0603200RFKEA | Vishay-Dale |
| SH-JVA_2-3 | 1 | 1x2 | Shunt, 100mil, Gold plated, Black | 382811-6 | AMP |
| U1 | 1 | | Precision Micropower Low Dropout Voltage Reference, 5-pin SOT-23, Pb-Free | LM4120IM5-4.1/NOBP | Texas Instruments |
| U2 | 1 | | 12-Bit Micro Power, RRO Digital-to-Analog Converter, 6-pin Tiny SOT23, Pb-Free | DAC121S101CIMK/NO PB | Texas Instruments |
| FID1, FID2, FID3 | 0 | | Fiducial mark. There is nothing to buy or mount. | N/A | N/A |
| GND | 0 | Black | Test Point, TH, Multipurpose, Black | 5011 | Keystone Electronics |
| VA-EXT | 0 | Red | Test Point, TH, Multipurpose, Red | 5010 | Keystone Electronics |

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- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Industry Canada Compliance (English)

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This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

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This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

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Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

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Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

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2. Use EVMs only after user obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after user obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless user gives the same notice above to the transferee. Please note that if user does not follow the instructions above, user will be subject to penalties of Radio Law of Japan.

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